



AP10.001AUS

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Miyoshi, et al.
Appl. No. : 09/844,155
Filed : April 27, 2001
For : COPPER ALLOY SUITABLE
FOR AN IC LEAD PIN FOR A
PIN GRID ARRAY PROVIDED
ON A PLASTIC SUBSTRATE
Examiner : Ip, S.
Group Art Unit : 1742

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

February 17, 2004

(Date)

Thomas R. Arno, Reg. No. 40,490

RESPONSE AFTER FINAL OFFICE ACTION

Mail Stop AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed October 17, 2003, and the Advisory Action mailed January 14, 2004, please consider the remarks presented in the accompanying pages. Applicant requests reconsideration and allowance of Claims 1-4.